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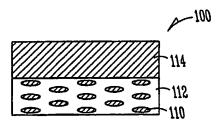
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(54) Title: MULTI-LAYER POLYMER-SOLDER HYBRID THERMAL INTERFACE MATERIAL FOR INTEGRATED HEAT SPREADER AND METHOD OF MAKING SAME



(57) Abstract: A process of making a multi-layer thermal interface material is depicted. The multi-layer thermal interface material is attached between an integrated heat spreader and a die. Processing of the multi-layer thermal interface material includes stamping or other pressure processing.





INTERNATIONAL SEARCH REPORT

Internatication No PCT/US2004/018164

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IPC 7	HO1L23/373			
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C DOCUME	ENTS CONSIDERED TO BE RELEVANT			
Category *	Citation of document, with indication, where appropriate, of the rel	evant passages	Relevant to claim No.	
Category	Onlaw or occurrent, manufacturer appropriate to			
χ	US 5 981 085 A (NINOMIYA ET AL)		1,2,5,6,	
^	9 November 1999 (1999-11-09)		16,19-21	
	column 4, line 10 - column 9, li	ne 42;	·	
	figures 2,8	• .		
γ .	US 4 782 893 A (THOMAS ET AL)		1,2,	
'	8 November 1988 (1988-11-08)		5-10,16,	
	•		18-24	
	*see Figure 2 and accompanying		ļ	
	description*			
Υ	US 2002/135984 A1 (GREENWOOD ALF	RED W ET	1,2,	
	AL) 26 September 2002 (2002-09-2	6)	5-10,16,	
	paragraphs [0036] - [0045], [00	517	18-24	
	[0056]; figures 1,4	J1],		
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X Furt	ner documents are listed in the continuation of box C.	X Patent family mem	bers are listed in annex.	
Special ca	tegories of cited documents :	"T" later document oublishe	d after the international filing date	
"A" docume	nt defining the general state of the art which is not	or priority date and not	in conflict with the application but principle or theory underlying the	
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1	5 February 2005	27/05/2005		
Name and r	nailing address of the ISA	Authorized officer		
	European Patent Office, P.B. 5818 Patentlaan 2 NL - 2280 HV Rijswijk		_	
	Tel. (+31-70) 340-2040, Tx. 31 651 epo nl. Fax: (+31-70) 340-3016	Cousins,	D	
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INTERNATIONAL SEARCH REPORT

International Application No PCT/US2004/018164

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C.(Continua Category °	ation) DOCUMENTS CONSIDERED TO BE RELEVANT Citation of document, with indication, where appropriate, of the relevant passages		Relevant to claim No.		
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Y	WO 02/091395 A (HONEYWELL INTERNATIONAL INC; NGUYEN, MY) 14 November 2002 (2002-11-14) the whole document		1,2, 5-10,16, 18-24		
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	10 (continuation of second sheet) (January 2004)				

International application No. PCT/US2004/018164

INTERNATIONAL SEARCH REPORT

Box II Observations where certain claims were found unsearchable (Continuation of item 2 of first sheet)
This International Search Report has not been established in respect of certain claims under Article 17(2)(a) for the following reasons:
Claims Nos.: because they relate to subject matter not required to be searched by this Authority, namely:
2. Claims Nos.: because they relate to parts of the International Application that do not comply with the prescribed requirements to such an extent that no meaningful International Search can be carried out, specifically:
3. Claims Nos.: because they are dependent claims and are not drafted in accordance with the second and third sentences of Rule 6.4(a).
Box III Observations where unity of invention is lacking (Continuation of item 3 of first sheet)
This International Searching Authority found multiple inventions in this international application, as follows:
see additional sheet
1. As all required additional search fees were timely paid by the applicant, this International Search Report covers all searchable claims.
2. As all searchable claims could be searched without effort justifying an additional fee, this Authority did not invite payment of any additional fee.
3. As only some of the required additional search fees were timely paid by the applicant, this International Search Report covers only those claims for which fees were paid, specifically claims Nos.:
No required additional search fees were timely paid by the applicant. Consequently, this International Search Report is restricted to the invention first mentioned in the claims; it is covered by claims Nos.:
1,2,5-10,16,18-24
Remark on Protest The additional search fees were accompanied by the applicant's protest. No protest accompanied the payment of additional search fees.

FURTHER INFORMATION CONTINUED FROM PCT/ISA/ 210

This International Searching Authority found multiple (groups of) inventions in this international application, as follows:

1. claims: 1,2,5-10,16,18-24

Claim 1, 2: thermal interface member having a solder preform disposed on a matrix material, insofar as the transition between the solder preform and the matrix is abrupt, the matrix being of a second heat transfer structure, with second heat transfer structures dispersed in the matrix, the second heat transfer structure being a polymer, the first heat transfer structures being of a material alternative to diamond (viz. graphite, inorganic dielectric particles, metal particles). Claims 5 - 10, 16 (insofar as the transition between the solder preform and the matrix is abrupt), 18 - 24.

2. claims: 1,3,4,16

Claim 1, thermal interface member having a solder preform disposed on a matrix material, insofar as the transition between the solder preform and the matrix is a concentration gradient. Claims 3, 4 directed to a thermal interface member having a solder preform disposed on a matrix material, with a middle heat transfer structure therebetween, the latter having a composition that is transitional between that of the matrix and that of the solder preform. Claim 16 (insofar as the transition between the solder preform and the matrix is a concentration gradient).

3. claims: 11-15

Claims 11-15: a process of forming a heat transfer composite comprising the steps of: mixing and casting a matrix comprising a plurality of first heat transfer structures within a second heat transfer structure of a curable material; and bonding the matrix to a solder layer and forming the matrix is by co-extruding and singulating.

4. claim: 17

Claim 17: Bonding a heat transfer subsystem to a die and a heat spreader at a temperature (Ttim -Tamb)/2.

INTERNATIONAL SEARCH REPORT

Internation No PCT/US2004/018164

Patent document cited in search report		Publication date -		Patent family member(s)		Publication date
ÚS 5981085	A	09-11-1999	GB GB JP	2311414 A 2327150 A 10150124 A	,B	24-09-1997 13-01-1999 02-06-1998
US 4782893	Α	08-11-1988	NONE			
US 2002135984	A1	26-09-2002	EP JP MX TW WO	1354353 A 2004518294 T PA03006498 A 552690 B 02059965 A	-	22-10-2003 17-06-2004 15-10-2003 11-09-2003 01-08-2002
WO 02091395	A	14-11-2002	US CA CN EP JP WO US	2001038093 AI 2442034 AI 1552078 A 1386327 AI 2004533705 T 02091395 AI 2004185273 AI	1 1 1	08-11-2001 14-11-2002 01-12-2004 04-02-2004 04-11-2004 14-11-2002 23-09-2004